

P54/74PCT273/A

OCTAL D FLIP-FLOP



FEATURES

- Function, Pinout, Speed and Drive Compatible with the Fastest Bipolar Logic
- "A" Versions for High Performance
- CMOS for Low Power Consumption—Typically 1/3 of FAST Bipolar Logic
- Edge Triggered D Flip-Flops
- 250MHz Typical Toggle Rate
- Buffered Common Clock
- Buffered, Asynchronous Master Reset
- Inputs and Outputs Interface Directly with TTL, NMOS, and CMOS Devices
- Input Clamp Diode to Limit Bus Reflections



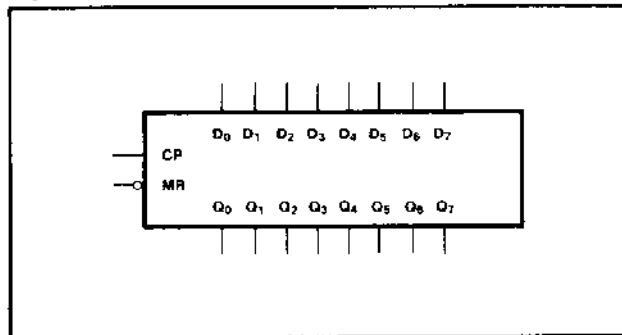
DESCRIPTION

The 'PCT273/A consists of eight edge triggered D-type flip-flops with individual D inputs and Q outputs. The common buffered clock (CP) and master reset (MR) load and reset (clear) all flip-flops simultaneously. The 'PCT273/A is an edge triggered

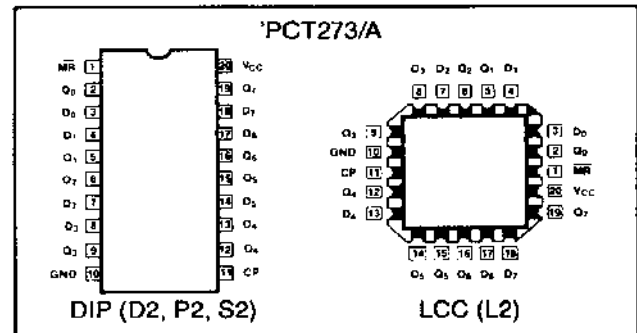
register. The state of each D input (one setup time before the low-to-high clock transition) is transferred to the corresponding flip-flop's Q output. All outputs will be forced low by a low voltage level on the MR input.



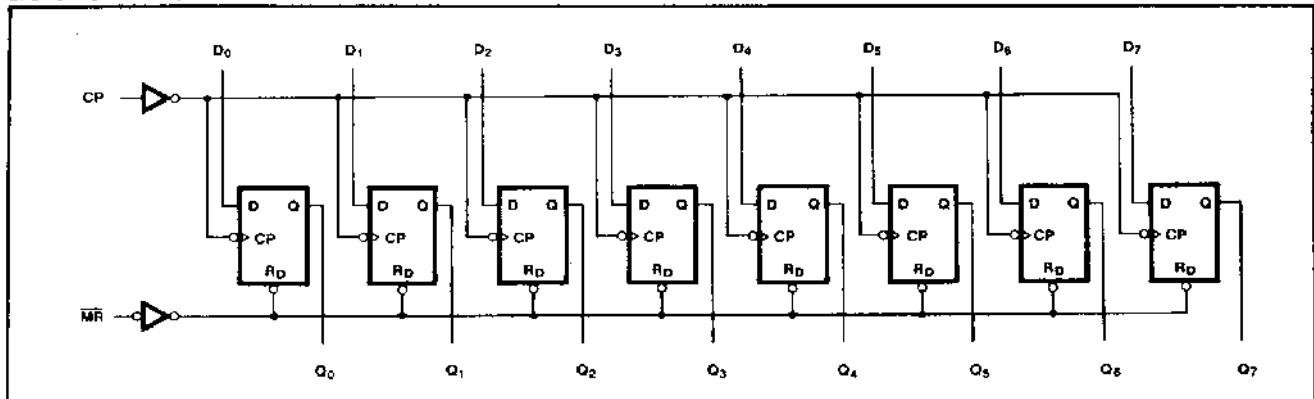
LOGIC SYMBOL



PIN CONFIGURATIONS



LOGIC DIAGRAM





ABSOLUTE MAXIMUM RATINGS^{1,2}

Symbol	Parameter	Value	Unit
T_{STG}	Storage Temperature	-65 to +150	°C
T_A	Ambient Temperature Under Bias	-55 to +125	°C
V_{CC}	V_{CC} Potential to Ground	-0.5 to +7.0	V
I_{IN}	Input Current	-30 to +5.0	mA

Notes:

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1. Operation beyond the limits set forth in the above table may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.

Symbol	Parameter	Value	Unit
I_{OUTPUT}	Current Applied to Output	100	mA
V_{IN}	Input Voltage	-0.5 to $V_{CC} + 0.5$	V
V_{OUT}	Voltage Applied to Output	-0.5 to $V_{CC} + 0.5$	V

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2. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V_{CC} or ground.

RECOMMENDED OPERATING CONDITIONS

Free Air Ambient Temperature	Min	Max
Military	-55°C	+125°C
Commercial	0°C	+70°C

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Supply Voltage (V_{CC})	Min	Max
Military	+4.5V	+5.5V
Commercial	+4.75V	+5.25V

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DC ELECTRICAL CHARACTERISTICS (Over recommended operating conditions)

Symbol	Parameter	Min	Typ ¹	Max	Units	V_{CC}	Conditions
V_{IH}	Input HIGH Voltage	2.0		$V_{CC} + 0.5$	V		
V_{IL}	Input LOW Voltage	-0.5		0.8	V		
V_H	Hysteresis		.35		V		All inputs
V_{CD}	Input clamp diode voltage			-1.2	V	MIN	$I_{IN} = -18\text{mA}$
V_{OH}	Output HIGH voltage	$V_{CC} = 3V, V_{IN} = 0.2V, \text{ or } V_{CC} - 0.2V$		$V_{CC} - 0.2$	V		$I_{OH} = -32\mu A$
		Military/Commercial (CMOS)		$V_{CC} - 0.2$	V	MIN	$I_{OH} = -300\mu A$
		Military (TTL)		2.4	V	MIN	$I_{OH} = -12\text{mA}$
		Commercial (TTL)		2.7	V	MIN	$I_{OH} = -15\text{mA}$
V_{OL}	Output LOW voltage	$V_{CC} = 3V, V_{IN} = 0.2V, \text{ or } V_{CC} - 0.2V$		0.2	V		$I_{OL} = 300\mu A$
		Military/Commercial (CMOS)		0.2	V	MIN	$I_{OL} = 300\mu A$
		Military (TTL)		0.5	V	MIN	$I_{OL} = 32\text{mA}$
		Commercial (TTL)		0.5	V	MIN	$I_{OL} = 48\text{mA}$
I_{IH}	Input HIGH Current			5	μA	MAX	$V_{IN} = V_{CC}$
I_{IL}	Input LOW Current			-5	μA	MAX	$V_{IN} = \text{GND}$
I_{IH}	Input HIGH Current ³			5	μA	MAX	$V_{OUT} = 2.7V$
I_{IL}	Input LOW Current ³			-5	μA	MAX	$V_{OUT} = 0.5V$
I_{OS}	Output short circuit ²	-60			mA	MAX	$V_{OUT} = 0.0V$
C_{IN}	Input capacitance ³		5	10	pF		All inputs
C_{OUT}	Output capacitance ³		9	12	pF		All outputs

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Notes:

1. Typical limits are at $V_{CC} = 5.0V, T_A = +25^\circ\text{C}$ ambient.
 2. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect

operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

3. This parameter is guaranteed but not tested.

DC CHARACTERISTICS (Over recommended operating conditions unless otherwise specified.)

Symbol	Parameter	Typ ¹	Max	Units	Conditions
I_{CCOC}	Quiescent Power Supply Current (CMOS inputs) Com'l Mil	.003 .003	0.3 0.5	mA mA	$V_{CC} = \text{MAX}$, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$, $f = 0$, Outputs Open
I_{CCOT}	Quiescent Power Supply Current (TTL inputs)		2.0	mA	$V_{CC} = \text{MAX}$, $V_{IN} = 3.4V^2$, $f = 0$, Outputs Open
I_{CCD}	Dynamic Power Supply Current ³		0.25	mA/ mHz	$V_{CC} = \text{MAX}$, One Bit Toggling, 50% Duty Cycle, $\overline{MR} = V_{CC}$, $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$, Outputs Open
I_{CC}	Total Power Supply Current ⁵		4.0	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, 50% Duty Cycle, Outputs Open, One Bit Toggling at $f_1 = 5\text{MHz}$, $\overline{MR} = V_{CC}$ and $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
			6.0	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, 50% Duty Cycle, Outputs Open, One Bit Toggling at $f_1 = 5\text{MHz}$, $\overline{MR} = V_{CC}$ and $V_{IN} = 3.4V$ or $V_{IN} = \text{GND}$
			7.8 ⁴	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, 50% Duty Cycle, Outputs Open, Eight Bits Toggling at $f_1 = 2.5\text{MHz}$, $\overline{MR} = V_{CC}$ and $V_{IN} \leq 0.2V$ or $V_{IN} \geq V_{CC} - 0.2V$
			16.8 ⁴	mA	$V_{CC} = \text{MAX}$, $f_0 = 10\text{MHz}$, 50% Duty Cycle, Outputs Open, Eight Bits Toggling at $f_1 = 2.5\text{MHz}$, $\overline{MR} = V_{CC}$ and $V_{IN} = 3.4V$ or $V_{IN} = \text{GND}$

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Notes:

- Typical values are at $V_{CC} = 5.0V$, $+25^\circ\text{C}$ ambient and maximum loading.
- Per TTL driven input ($V_{IN} = 3.4V$); all other inputs at V_{CC} or GND.
- This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
- Values for these conditions are examples of the I_{CC} formula. These limits are guaranteed but not tested.
- $I_{CC} = I_{CCOC} + I_{CCOT} D_H N_I + I_{CCD} (f_0/2 + f_1 N_I)$
 I_{CCOC} = Quiescent Current with CMOS input levels

I_{CCO} = Power Supply Current for a TTL High Input ($V_{IN} = 3.4V$)

D_H = Duty Cycle for TTL Inputs High

N_I = Number of TTL Inputs at D_H

I_{CCD} = Dynamic Current Caused by an Input Transition Pair (HLH or LHL)

f_0 = Clock Frequency for Register Devices (Zero for Non-Register Devices)

f_1 = Input Frequency

N_I = Number of Inputs at f_1

All currents are in milliamps and all frequencies are in megahertz.

MODE SELECT-FUNCTION TABLE

Operating Mode	Inputs			Output
	$\overline{MR}$	CP	D_n	Q_n
Reset (clear)	L	X	X	L
Load '1'	H	┐	h	H
Load '0'	H	┘	l	L

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H = HIGH Voltage Level steady state

h = HIGH Voltage Level one setup time prior to LOW-to-HIGH clock transition

L = LOW Voltage Level steady state

l = LOW Voltage Level one setup time prior to the LOW-to-HIGH transition

X = Don't Care

┐ = LOW-to-HIGH clock transition



AC CHARACTERISTICS

Symbol	Parameter	P54/74PCT273					P54/74PCT273A					Units	Fig. No.
		$T_A=+25^\circ\text{C}$ $V_{CC}=+5.0\text{V}$		MIL		COM'L	$T_A=+25^\circ\text{C}$ $V_{CC}=+5.0\text{V}$		MIL		COM'L		
		Typ.	Min. ¹	Max.	Min. ¹	Max.	Typ.	Min. ¹	Max.	Min. ¹	Max.		
t_{PLH}	Propagation Delay	4.5	2.0	10.0	2.0	9.0	4.5	2.0	8.3	2.0	7.2	ns	1
t_{PHL}	Clock to Output	4.5	2.0	10.0	2.0	9.0	4.5	2.0	8.3	2.0	7.2	ns	5
t_{PLH}	Propagation Delay	7.0	2.0	12.5	2.0	11.0	5.0	2.0	8.3	2.0	7.2	ns	1
t_{PHL}	MR to Output	6.3	2.0	11.5	2.0	10.0	5.0	2.0	8.3	2.0	7.2	ns	6

Note: AC Characteristics guaranteed with $C_L = 50\text{pF}$ as shown in Figure 1.

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AC OPERATING REQUIREMENTS

Symbol	Parameter	P54/74PCT273					P54/74PCT273A					Units	Fig. No.
		$T_A=+25^\circ\text{C}$ $V_{CC}=+5.0\text{V}$		MIL		COM'L	$T_A=+25^\circ\text{C}$ $V_{CC}=+5.0\text{V}$		MIL		COM'L		
		Typ.	Min.	Max.	Min.	Max.	Typ.	Min.	Max.	Min.	Max.		
$t_s(H)$	Setup Time, HIGH	0.8	3.0		3.0		0.8	2.0		2.0		ns	4
$t_s(L)$	or LOW Data to CP	0.8	3.0		3.0		0.8	2.0		2.0			
$t_h(H)$	Hold Time, HIGH	0.6	1.0		1.0		0.6	1.0		1.0		ns	4
$t_h(L)$	or LOW Data to CP	0.8	1.0		1.0		0.8	1.0		1.0			
$t_w(H)$	Clock Pulse Width ² , HIGH or LOW	2.0	7.0		6.0		2.0	6.0		6.0		ns	5
$t_w(L)$		2.0	6.0		6.0		2.0	6.0		6.0			
$t_w(H)$	MR Pulse Width, HIGH or LOW	3.5	6.0		6.0		3.5	6.0		6.0		ns	6
$t_w(L)$		3.5	6.0		6.0		3.5	6.0		6.0			
t_{rec}	Recovery Time, MR to CP	2.0	3.0		3.0		1.5	2.5		2.0		ns	6

Notes:

- Minimum limits are guaranteed but not tested on Propagation Delays.
- With one data channel toggling, $t_w(L) = t_w(H) = 2.0\text{ns}$ and $t_s = t_h = 1.0\text{ns}$.

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ORDERING INFORMATION

PxxPCT	xxxx	x	x	x	
Temp. Class	Device type	Package	Temperature	Processing	
				B	MIL-STD-883, Class B
				C	0°C to +70°C
				M	-55°C to +125°C
				P	Plastic DIP
				D	CERDIP
				S	Small Outline IC
				L	Leadless Chip Carrier
				273	OCTAL D FLIP-FLOP
				273A	Fast OCTAL D FLIP-FLOP
				74	Commercial
				54	Military

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TECHDOC 1506